



# BSS84AKV

50 V, 170 mA dual P-channel Trench MOSFET

28 December 2022

Product data sheet

## 1. General description

Dual P-channel enhancement mode Field-Effect Transistor (FET) in an ultra small and flat lead SOT666 Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Logic-level compatible
- Very fast switching
- Trench MOSFET technology
- ESD protection up to 1 kV

## 3. Applications

- Relay driver
- High-speed line driver
- High-side loadswitch
- Switching circuits

## 4. Quick reference data

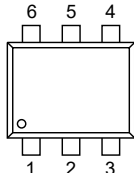
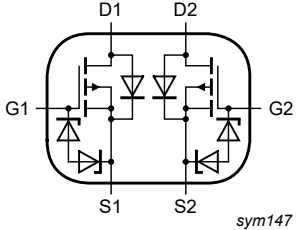
Table 1. Quick reference data

| Symbol   | Parameter                        | Conditions  | Min | Typ | Max  | Unit     |
|--|----------------------------------|---|-----|-----|------|----------|
| <b>Per transistor</b>                          |                                  |   |     |     |      |          |
| $V_{DS}$                                       | drain-source voltage             | $T_j = 25\text{ °C}$  | -   | -   | -50  | V        |
| $V_{GS}$                                       | gate-source voltage              |   | -20 | -   | 20   | V        |
| $I_D$  | drain current                    | $V_{GS} = -10\text{ V}; T_{amb} = 25\text{ °C}$                   | [1] | -   | -170 | mA       |
| <b>Static characteristics (per transistor)</b> |                                  |   |     |     |      |          |
| $R_{DSon}$                                     | drain-source on-state resistance | $V_{GS} = -10\text{ V}; I_D = -100\text{ mA}; T_j = 25\text{ °C}$ | -   | 4.5 | 7.5  | $\Omega$ |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline   | Graphic symbol   |
|-----|--------|-------------|--|--|
| 1   | S1     | source 1    |  <p><b>SOT666</b></p> |  <p><i>sym147</i></p> |
| 2   | G1     | gate 1      |  |  |
| 3   | D2     | drain 2     |  |  |
| 4   | S2     | source 2    |  |  |
| 5   | G2     | gate 2      |  |  |
| 6   | D1     | drain 1     |  |  |

## 6. Ordering information

Table 3. Ordering information

| Type number | Package |   |         |
|-------------|---------|---|---------|
|             | Name    | Description   | Version |
| BSS84AKV    | SOT666  | plastic, surface-mounted package; 6 leads; 0.5 mm pitch; 1.6 mm x 1.2 mm x 0.55 mm body | SOT666  |

## 7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| BSS84AKV    | EG           |

## 8. Limiting values

**Table 5. Limiting values**

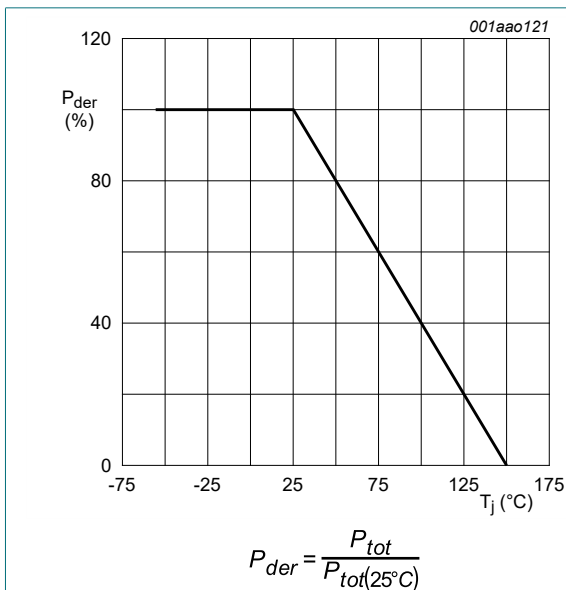
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol                    | Parameter                       | Conditions   |     | Min | Max  | Unit |
|---------------------------|---------------------------------|--|-----|-----|------|------|
| <b>Per transistor</b>     |                                 |  |     |     |      |      |
| V <sub>DS</sub>           | drain-source voltage            | T <sub>j</sub> = 25 °C   |     | -   | -50  | V    |
| V <sub>GS</sub>           | gate-source voltage             |  |     | -20 | 20   | V    |
| I <sub>D</sub>            | drain current                   | V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C              | [1] | -   | -170 | mA   |
|                           |                                 | V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 100 °C             | [1] | -   | -110 | mA   |
| I <sub>DM</sub>           | peak drain current              | T <sub>amb</sub> = 25 °C; single pulse; t <sub>p</sub> ≤ 10 μs |     | -   | -0.7 | A    |
| P <sub>tot</sub>          | total power dissipation         | T <sub>amb</sub> = 25 °C                                       | [2] | -   | 330  | mW   |
|                           |                                 |  | [1] | -   | 390  | mW   |
|                           |                                 | T <sub>sp</sub> = 25 °C  |     | -   | 1090 | mW   |
| <b>Per device</b>         |                                 |  |     |     |      |      |
| P <sub>tot</sub>          | total power dissipation         | T <sub>amb</sub> = 25 °C                                       | [2] | -   | 500  | mW   |
| T <sub>j</sub>            | junction temperature            |  |     | -55 | 150  | °C   |
| T <sub>amb</sub>          | ambient temperature             |  |     | -55 | 150  | °C   |
| T <sub>stg</sub>          | storage temperature             |  |     | -65 | 150  | °C   |
| <b>Source-drain diode</b> |                                 |  |     |     |      |      |
| I <sub>S</sub>            | source current                  | T <sub>amb</sub> = 25 °C                                       | [1] | -   | -170 | mA   |
| <b>ESD maximum rating</b> |                                 |  |     |     |      |      |
| V <sub>ESD</sub>          | electrostatic discharge voltage | HBM  | [3] | -   | 1000 | V    |

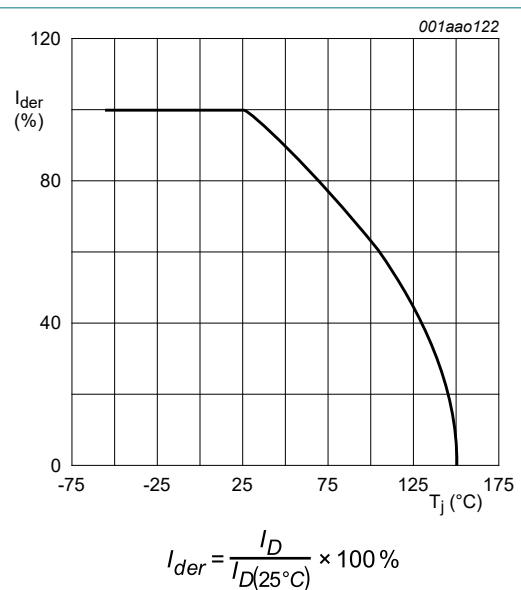
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

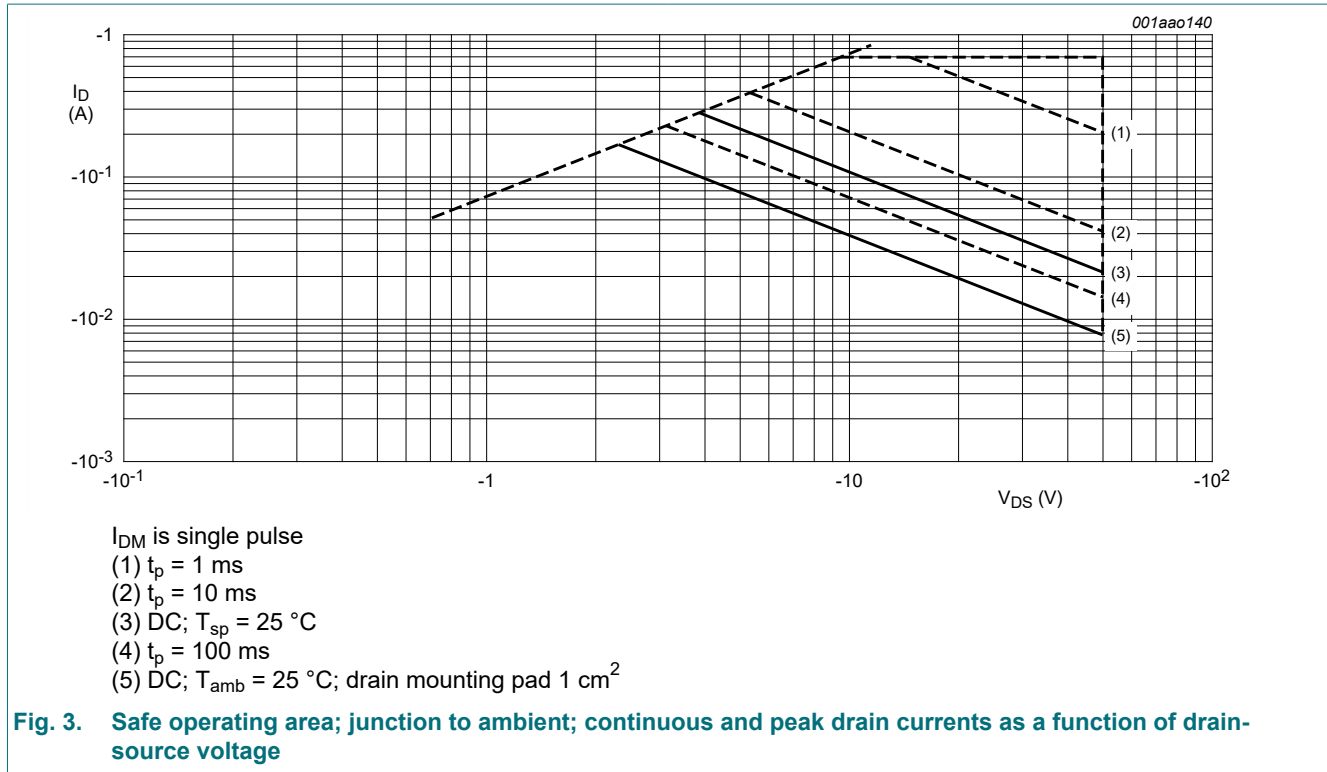
[3] Measured between all pins.



**Fig. 1. Normalized total power dissipation as a function of junction temperature**



**Fig. 2. Normalized continuous drain current as a function of junction temperature**



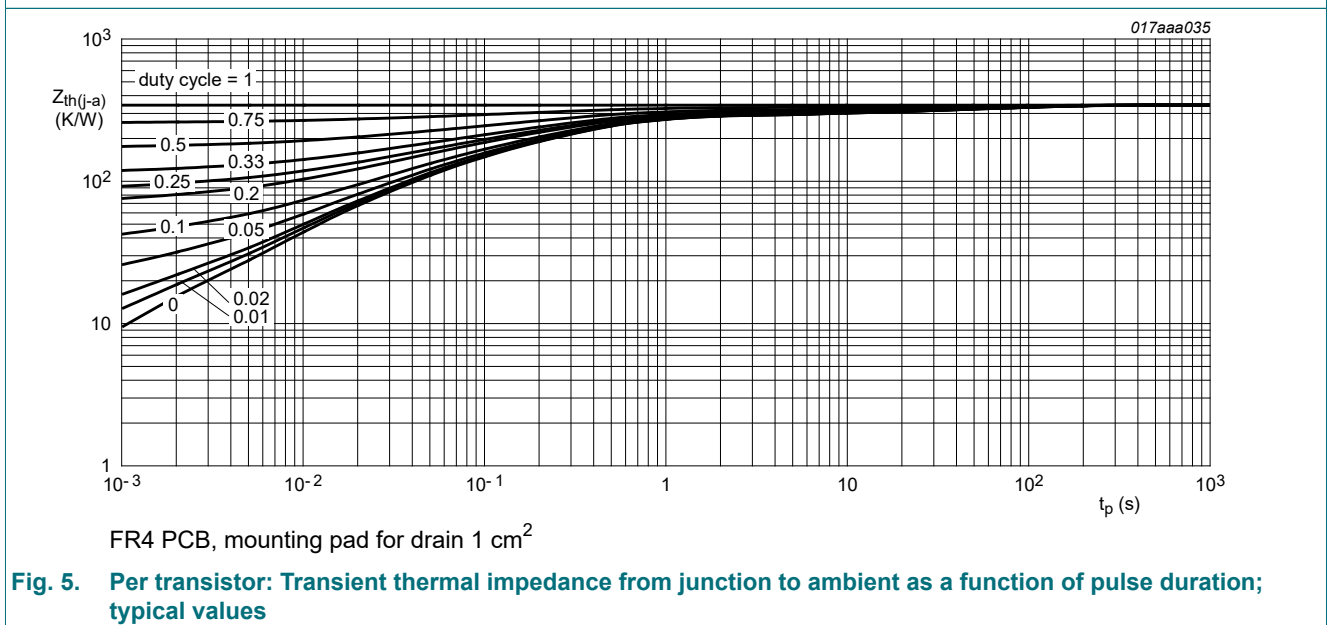
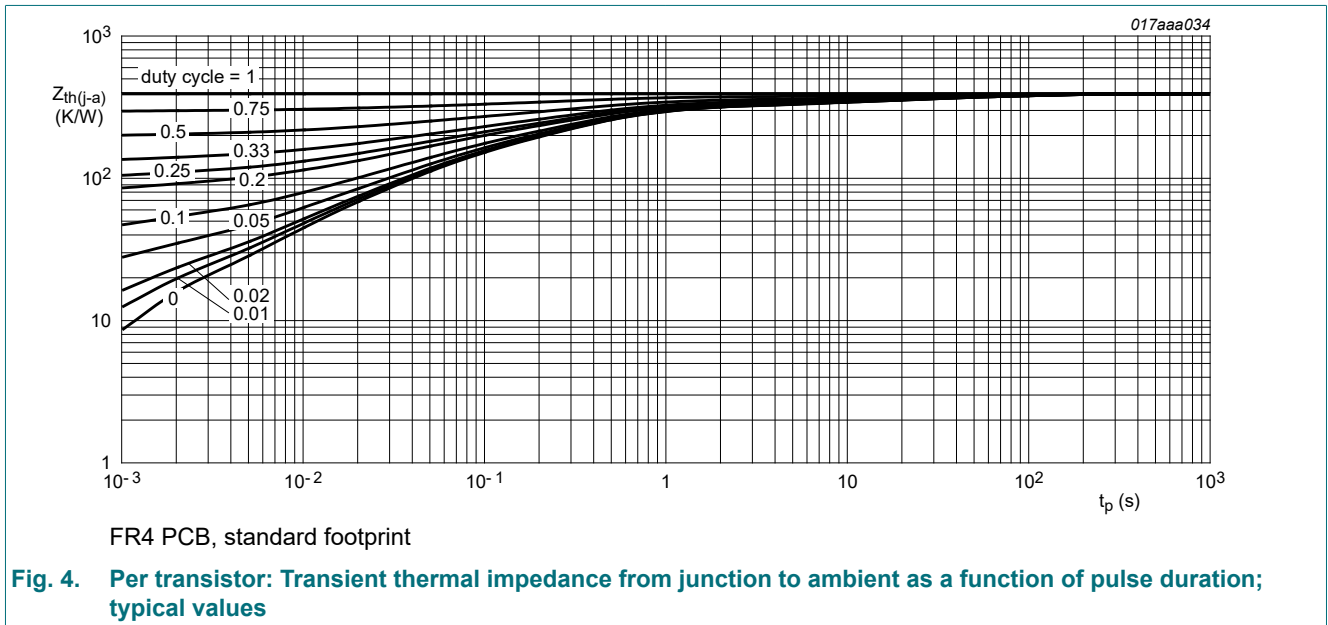
## 9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol                | Parameter  | Conditions  | Min | Typ | Max | Unit |     |
|-----------------------|--|-------------|-----|-----|-----|------|-----|
| <b>Per transistor</b> |  |             |     |     |     |      |     |
| $R_{th(j-a)}$         | thermal resistance from junction to ambient      | in free air | [1] | -   | 330 | 380  | K/W |
|                       |  |             | [2] | -   | 280 | 320  | K/W |
| $R_{th(j-sp)}$        | thermal resistance from junction to solder point |             | -   | -   | 115 | K/W  |     |
| <b>Per device</b>     |  |             |     |     |     |      |     |
| $R_{th(j-a)}$         | thermal resistance from junction to ambient      | in free air | [1] | -   | -   | 250  | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

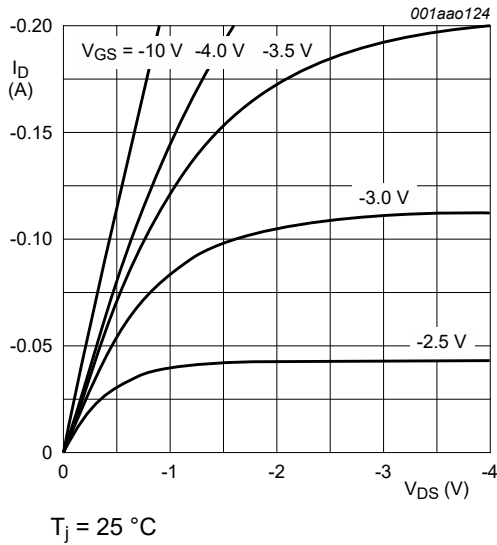
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.



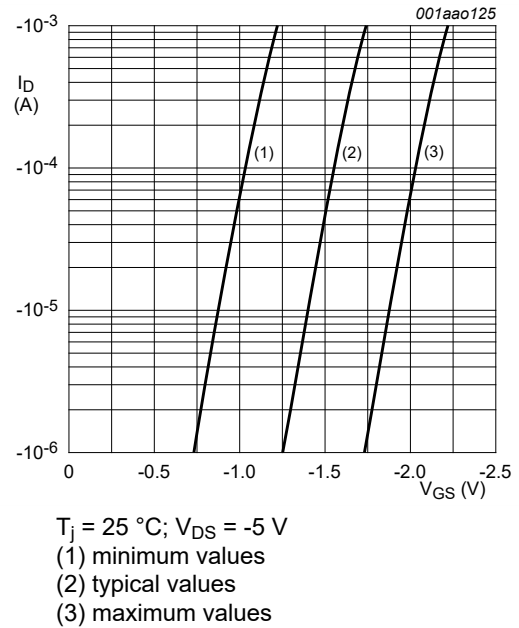
## 10. Characteristics

Table 7. Characteristics

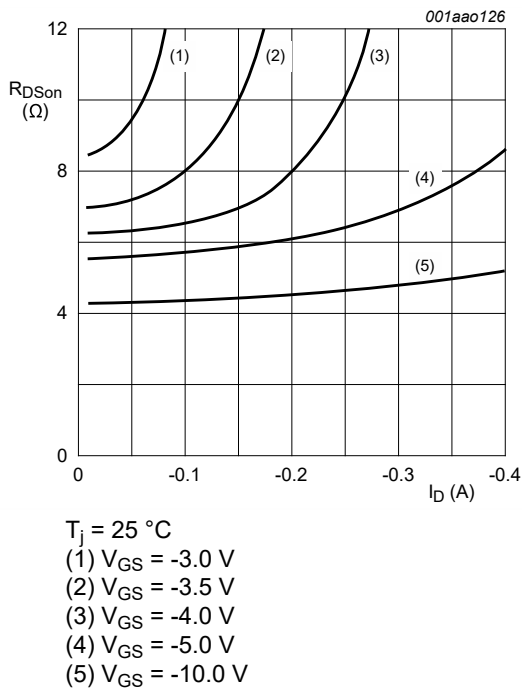
| Symbol  | Parameter                        | Conditions  | Min   | Typ   | Max  | Unit     |
|---|----------------------------------|---|---|-------|------|----------|
| <b>Static characteristics (per transistor)</b>  |                                  |   |   |       |      |          |
| $V_{(BR)DSS}$                                   | drain-source breakdown voltage   | $I_D = -10 \mu A$ ; $V_{GS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                      | -50   | -     | -    | V        |
| $V_{GSth}$                                      | gate-source threshold voltage    | $I_D = -250 \mu A$ ; $V_{DS} = V_{GS}$ ; $T_j = 25 \text{ }^\circ C$                  | -1.1  | -1.6  | -2.1 | V        |
| $I_{DSS}$                                       | drain leakage current            | $V_{DS} = -50 V$ ; $V_{GS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                       | -   | -     | -1   | $\mu A$  |
|   |                                  | $V_{DS} = -50 V$ ; $V_{GS} = 0 V$ ; $T_j = 150 \text{ }^\circ C$                      | -   | -     | -2   | $\mu A$  |
| $I_{GSS}$                                       | gate leakage current             | $V_{GS} = -20 V$ ; $V_{DS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                       | -   | -     | -10  | $\mu A$  |
|   |                                  | $V_{GS} = 20 V$ ; $V_{DS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                        | -   | -     | -10  | $\mu A$  |
| $R_{DSon}$                                      | drain-source on-state resistance | $V_{GS} = -10 V$ ; $I_D = -100 mA$ ; $T_j = 25 \text{ }^\circ C$                      | -   | 4.5   | 7.5  | $\Omega$ |
|   |                                  | $V_{GS} = -10 V$ ; $I_D = -100 mA$ ; $T_j = 150 \text{ }^\circ C$                     | -   | 8     | 13.5 | $\Omega$ |
|   |                                  | $V_{GS} = -5 V$ ; $I_D = -100 mA$ ; $T_j = 25 \text{ }^\circ C$                       | -   | 5.7   | 8.5  | $\Omega$ |
| $g_{fs}$  | forward transconductance         | $V_{DS} = -10 V$ ; $I_D = -100 mA$ ; $T_j = 25 \text{ }^\circ C$                      | -   | 150   | -    | mS       |
| <b>Dynamic characteristics (per transistor)</b> |                                  |   |   |       |      |          |
| $Q_{G(tot)}$                                    | total gate charge                | $V_{DS} = -25 V$ ; $I_D = -200 mA$ ; $V_{GS} = -5 V$ ;<br>$T_j = 25 \text{ }^\circ C$ | -   | 0.26  | 0.35 | nC       |
| $Q_{GS}$  | gate-source charge               |   | -   | 0.12  | -    | nC       |
| $Q_{GD}$  | gate-drain charge                |   | -   | 0.09  | -    | nC       |
| $C_{iss}$                                       | input capacitance                | $V_{DS} = -25 V$ ; $f = 1 MHz$ ; $V_{GS} = 0 V$ ;<br>$T_j = 25 \text{ }^\circ C$      | -   | 24    | 36   | pF       |
| $C_{oss}$                                       | output capacitance               |   | -   | 4.5   | -    | pF       |
| $C_{rss}$                                       | reverse transfer capacitance     |   | -   | 1.3   | -    | pF       |
| $t_{d(on)}$                                     | turn-on delay time               |   | $V_{DS} = -30 V$ ; $R_L = 250 \Omega$ ; $V_{GS} = -10 V$ ;<br>$R_{G(ext)} = 6 \Omega$ ; $T_j = 25 \text{ }^\circ C$ | -     | 13   | 26       |
| $t_r$   | rise time                        | -   |   | 11    | -    | ns       |
| $t_{d(off)}$                                    | turn-off delay time              | -   |   | 48    | 96   | ns       |
| $t_f$   | fall time                        | -   |   | 25    | -    | ns       |
| <b>Source-drain diode (per transistor)</b>      |                                  |   |   |       |      |          |
| $V_{SD}$  | source-drain voltage             | $I_S = -115 mA$ ; $V_{GS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                        | -0.48   | -0.85 | -1.2 | V        |



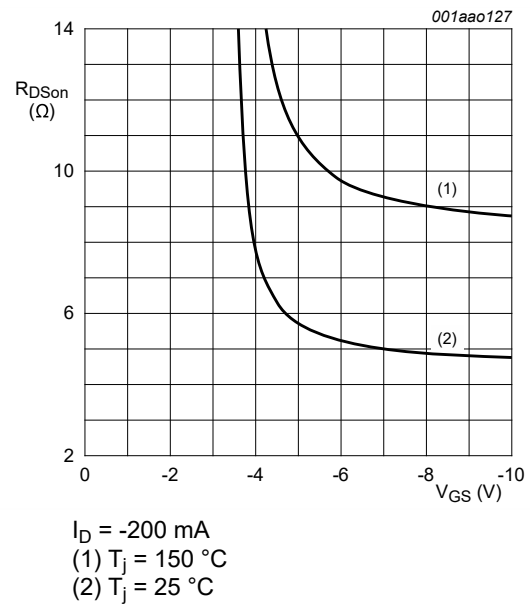
**Fig. 6. Output characteristics; drain current as a function of drain-source voltage; typical values**



**Fig. 7. Sub-threshold drain current as a function of gate-source voltage**



**Fig. 8. Drain-source on-state resistance as a function of drain current; typical values**



**Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values**

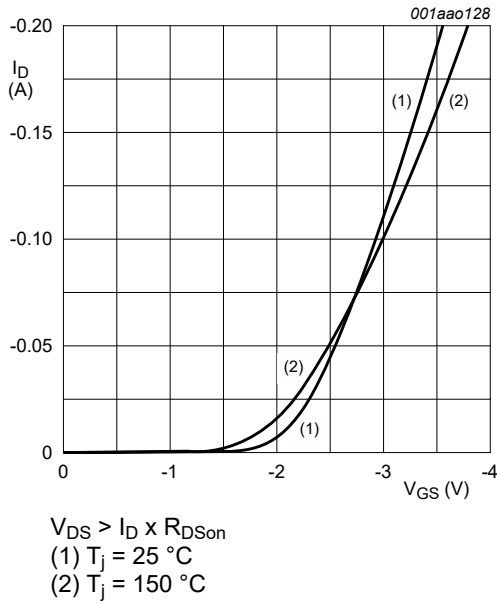


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

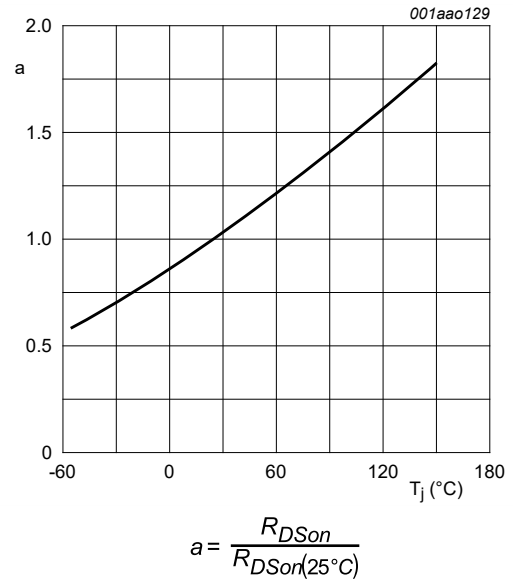


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

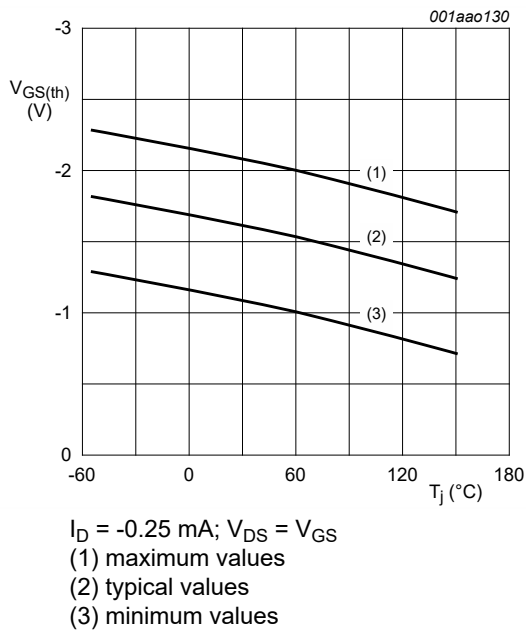


Fig. 12. Gate-source threshold voltage as a function of junction temperature

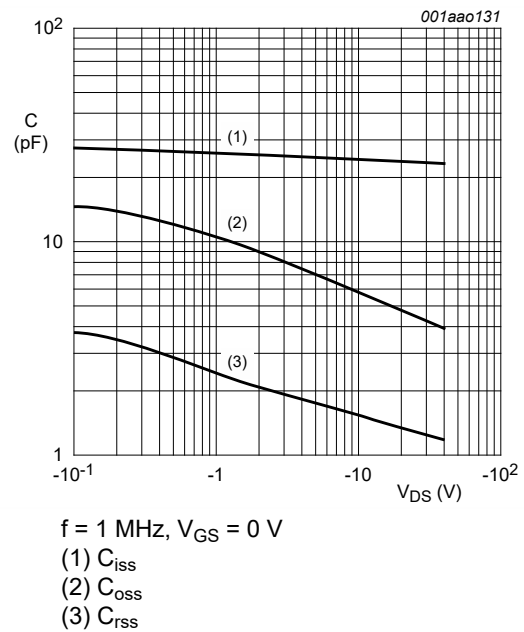


Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



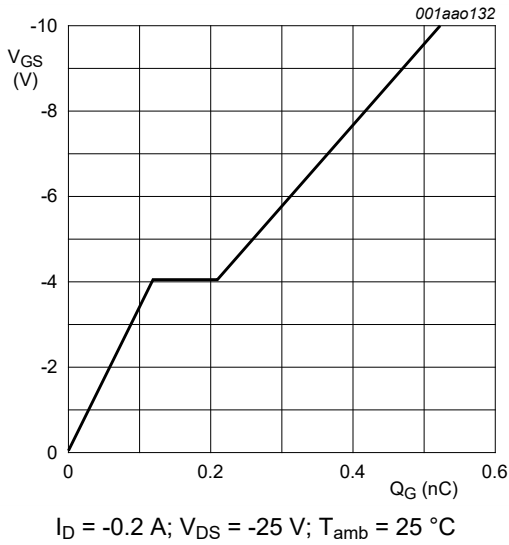


Fig. 14. Gate-source voltage as a function of gate charge; typical values

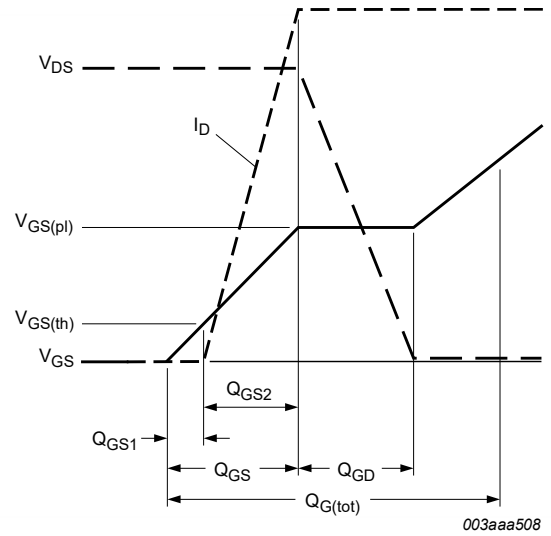
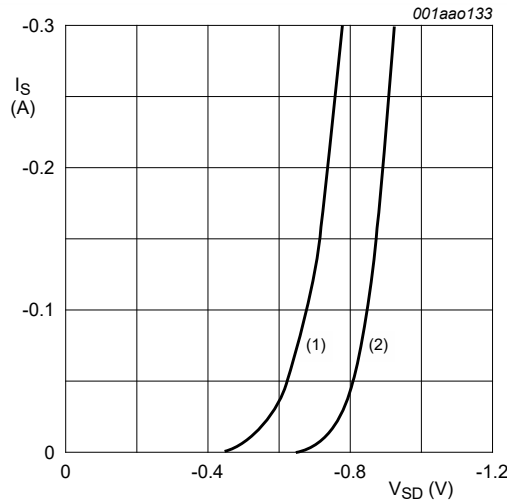


Fig. 15. Gate charge waveform definitions



$V_{GS} = 0$  V  
 (1)  $T_j = 150$  °C  
 (2)  $T_j = 25$  °C

Fig. 16. Source current as a function of source-drain voltage; typical values

## 11. Test information

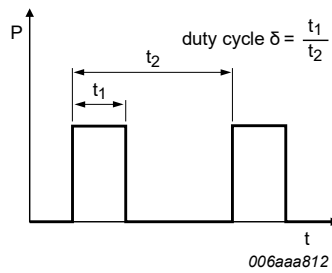


Fig. 17. Duty cycle definition

12. Package outline

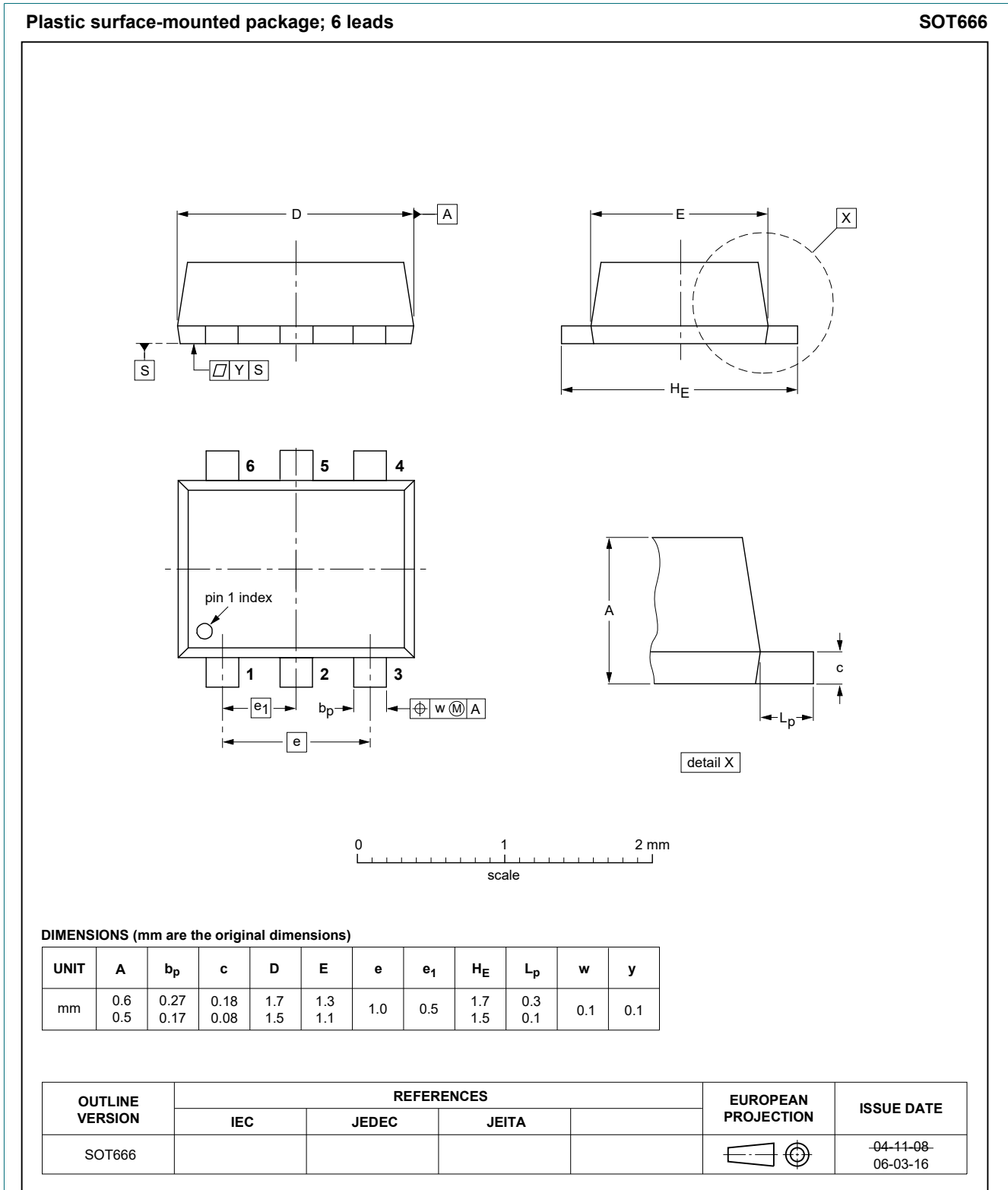


Fig. 18. Package outline SOT666

### 13. Soldering

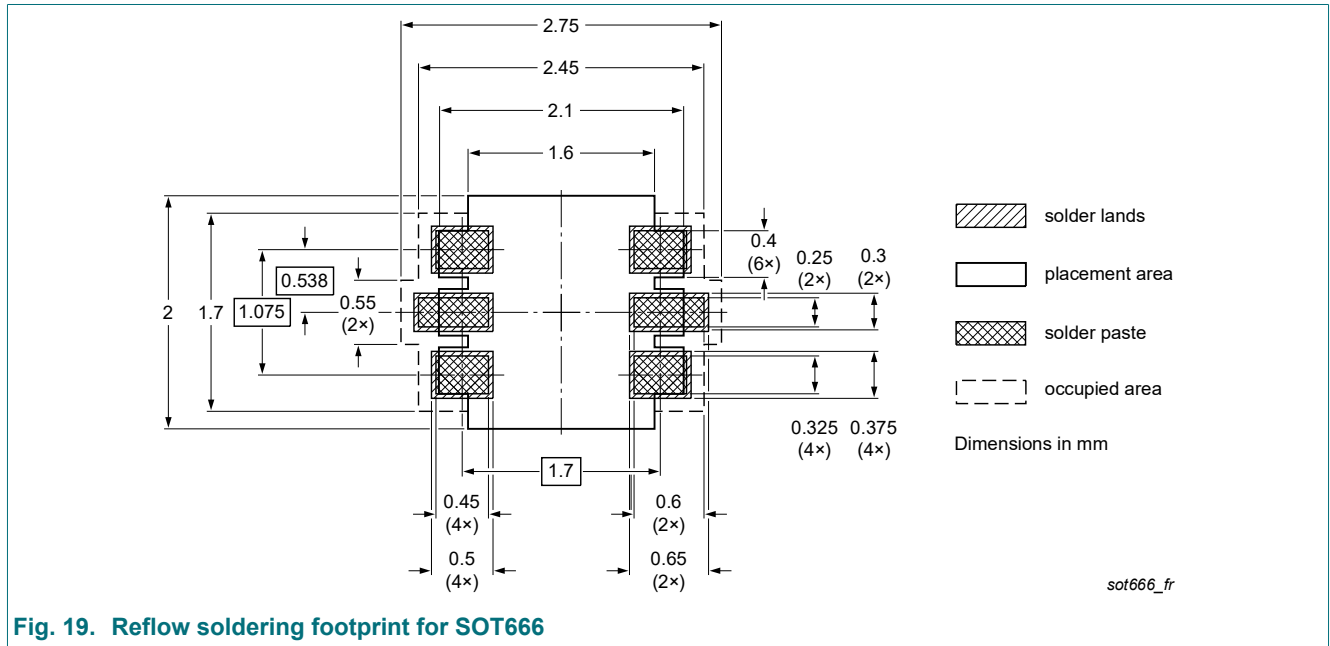


Fig. 19. Reflow soldering footprint for SOT666

## 14. Revision history

Table 8. Revision history

| Data sheet ID  | Release date   | Data sheet status  | Change notice | Supersedes   |
|----------------|--|--------------------|---------------|--------------|
| BSS84AKV v.2   | 20221228   | Product data sheet | -             | BSS84AKV v.1 |
| Modifications: | <ul style="list-style-type: none"><li>• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia</li><li>• Legal texts have been adapted to the new company name where appropriate</li><li>• Product changed to non-automotive qualification</li></ul> |                    |               |              |
| BSS84AKV v.1   | 20110519   | Product data sheet | -             | -            |

## 15. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 28 December 2022

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